![VISHAY]

New Product

Vishay Siliconix

Precision Monolithic Quad SPST
Low-Voltage CMOS Analog Switches

FEATURES

- 2.7- thru 12-V Single Supply or ±3- thru ±6-Dual Supply
- On-Resistance—$r_{DS(on)}$: 17 Ω
- Fast Switching—t_{ON}: 19 ns —t_{OFF}: 12 ns
- TTL, CMOS Compatible
- Low Leakage: 0.25 nA
- 2000-V ESD Protection

BENEFITS

- Widest Dynamic Range
- Low Signal Errors and Distortion
- Break-Before-Make Switching Action
- Simple Interfacing

APPLICATIONS

- Precision Automatic Test Equipment
- Precision Data Acquisition
- Communication Systems
- Battery Powered Systems
- Computer Peripherals
- SDSL, DSLAM
- Audio and Video Signal Routing

DESCRIPTION

The DG411L/412L/413L are low voltage pin-for-pin compatible companion devices to the industry standard DG411/412/413 with improved performance

Using BiCMOS wafer fabrication technology allows the DG411L/412L/413L to operate on single and dual supplies. Single supply voltage ranges from 3 to 12 V while dual supply operation is recommended with ±3 to ±6 V.

Combining high speed (t_{ON}: 19 ns), flat $r_{DS(on)}$ over the analog signal range (5 Ω), minimal insertion lose (–3 dB at 280 MHz), and excellent crosstalk and off-isolation performance (–50 dB at 50 MHz), the DG411L/412L/413L are ideally suited for audio and video signal switching.

The DG411L and DG412L respond to opposite control logic as shown in the Truth Table. The DG413L has two normally open and two normally closed switches.
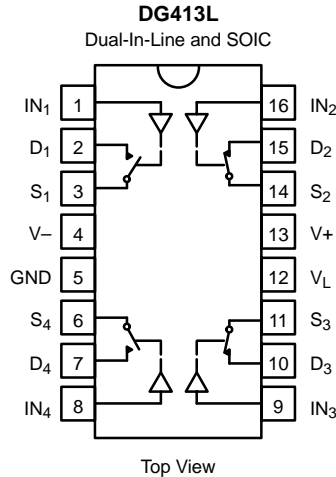
FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

DG411L/412L

TSSOP and SOIC

Top View
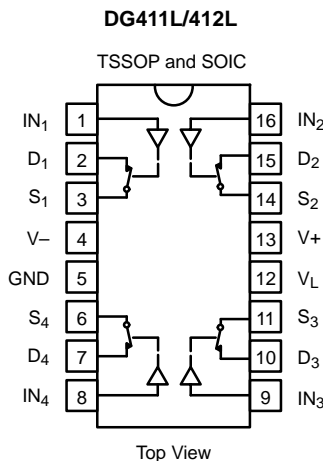
TRUTH TABLE		
Logic	DG411L	DG412L
0	ON	OFF
1	OFF	ON

Logic "0" ≤ 0.8 V
Logic "1" ≥ 2.4 V

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

DG413L
Dual-In-Line and SOIC

IN$_1$	1		16	IN$_2$
D$_1$	2		15	D$_2$
S$_1$	3		14	S$_2$
V–	4		13	V+
GND	5		12	V$_L$
S$_4$	6		11	S$_3$
D$_4$	7		10	D$_3$
IN$_4$	8		9	IN$_3$

Top View

TRUTH TABLE

Logic	SW$_1$, SW$_4$	SW$_2$, SW$_3$
0	OFF	ON
1	ON	OFF

Logic "0" $\leq$ 0.8 V
Logic "1" $\geq$ 2.4 V

ORDERING INFORMATION

Temp Range	Package	Part Number
DG411L/412L		
–40 to 85°C	16-Pin Narrow SOIC	DG411LDY
		DG412LDY
	16-Pin TSSOP	DG411LDQ
		DG412LDQ
DG413L		
–40 to 85°C	16-Pin Narrow SOIC	DG413LDY
	16-Pin TSSOP	DG413LDQ

ABSOLUTE MAXIMUM RATINGS

V+ to V– . . . . –0.3 TO 13 V

GND to V– . . . . 7 V

V$_L$ . . . . (GND –0.3 V) to (V+) +0.3 V

I$_N$[a], V$_S$, V$_D$ . . . . –0.3 to (V+ +0.3 V) or 30 mA, whichever occurs first

Continuous Current (Any Terminal) . . . . 30 mA

Peak Current, S or D (Pulsed 1 ms, 10% Duty Cycle) . . . . 100 mA

Storage Temperature   (DQ, DY Suffix) . . . . –65 to 125°C

Power Dissipation (Package)[b]
16-Pin TSSOP[c] . . . . 450 mW
16-Pin SOIC[d] . . . . 650 mW

Notes:
a.   Signals on S$_X$, D$_X$, or IN$_X$ exceeding V+ or V– will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
b.   All leads welded or soldered to PC Board.
c.   Derate 7 mW/°C above 75°C
d.   Derate 7.6 mW/°C above 75°C

SPECIFICATIONS[a] (SINGLE SUPPLY 12 V)

Parameter	Symbol	Test Conditions Unless Specified $V+ = 12$ V, $V- = 0$ V $V_L = 5$ V, $V_{IN} = 2.4$ V, 0.8 V[f]	Temp[b]	Limits −40 to 85°C Min[d]	Typ[c]	Max[d]	Unit
Analog Switch							
Analog Signal Range[e]	V_{ANALOG}		Full	0		12	V
Drain-Source On-Resistance	$r_{DS(on)}$	$V+ = 10.8$ V, $V- = 0$ V $I_S = -10$ mA, $V_D = 2/9$ V	Room Full		20	30 40	Ω
Switch Off Leakage Current	$I_{S(off)}$	$V_D = 1/11$ V, $V_S = 11/1$ V	Room Full	−0.1 −2.5	±0.01	0.1 2.5	nA
	$I_{D(off)}$		Room Full	−0.1 −2.5	±0.01	0.1 2.5	
Channel On Leakage Current	$I_{D(on)}$	$V_S = V_D = 11/1$ V	Room Full	−0.2 −5	±0.01	0.2 5	
Digital Control							
Input Current, V_{IN} Low	I_{IL}	V_{IN} Under Test = 0.8 V	Full	−1	0.01	1	μA
Input Current, V_{IN} High	I_{IH}	V_{IN} Under Test = 2.4 V	Full	−1		1	
Dynamic Characteristics							
Turn-On Time	t_{ON}	$R_L = 300$ Ω, $C_L = 35$ pF $V_S = 5$ V See Figure 2	Room Full		20	50 60	ns
Turn-Off Time	t_{OFF}		Room Full		12	30 40	
Break-Before-Make Time Delay	t_D	DG413L Only, $V_S = 5$ V $R_L = 300$ Ω, $C_L = 35$ pF	Room		6		
Charge Injection[e]	Q	$V_g = 0$ V, $R_g = 0$ Ω, $C_L = 10$ nF	Room		5		pC
Off Isolation[e]	OIRR	$R_L = 50$ Ω, $C_L = 5$ pF, $f = 1$ MHz	Room		71		dB
Channel-to-Channel Crosstalk[e]	X_{TALK}		Room		95		
Source Off Capacitance[e]	$C_{S(off)}$	$f = 1$ MHz	Room		5		pF
Drain Off Capacitance[e]	$C_{D(off)}$		Room		6		
Channel On Capacitance[e]	$C_{D(on)}$		Room		15		
Power Supplies							
Positive Supply Current	I+	$V_{IN} = 0$ or 5 V	Room Full		0.02	1 5	μA
Negative Supply Current	I−		Room Full	−1 −5	−0.002		
Logic Supply Current	I_L		Room Full		0.002	1 5	
Ground Current	I_{GND}		Room Full	−1 −5	−0.002		

SPECIFICATIONS[a] (DUAL SUPPLY ±5 V)

Parameter	Symbol	Test Conditions Unless Specified $V+ = 5$ V, $V- = -5$ V $V_L = 5$ V, $V_{IN} = 2.4$ V, 0.8 V[f]	Temp[b]	Limits −40 to 85°C Min[d]	Typ[c]	Max[d]	Unit
Analog Switch							
Analog Signal Range[e]	V_{ANALOG}		Full	−5		5	V
Drain-Source On-Resistance	$r_{DS(on)}$	$V+ = 5$ V, $V- = -5$ V $I_S = -10$ mA, $V_D = ±3.5$ V	Room Full		20	30 40	Ω
Switch Off Leakage Current[g]	$I_{S(off)}$	$V+ = 5$ V, $V- = -5$ V $V_D = ±4.5$ V, $V_S = ∓4.5$ V	Room Full	−0.1 −2.5	±0.01 ±0.5	0.1 2.5	nA
	$I_{D(off)}$		Room Full	−0.1 −2.5	±0.01	0.1 2.5	
Channel On Leakage Current[g]	$I_{D(on)}$	$V+ = 5$ V, $V- = -5$ V $V_S = V_D = ±4.5$ V	Room Full	−0.2 −5	±0.01 ±0.5	0.2 5	

SPECIFICATIONS[a] (DUAL SUPPLY ± 5 V)

Parameter	Symbol	Test Conditions Unless Specified $V+ = 5\ V$, $V- = -5\ V$ $V_L = 5\ V$, $V_{IN} = 2.4\ V$, $0.8\ V^f$	Temp[b]	Limits −40 to 85°C Min[d]	Typ[c]	Max[d]	Unit
Digital Control							
Input Current, V_{IN} Low[e]	I_{IL}	V_{IN} Under Test = 0.8 V	Full	−1	0.05	1	μA
Input Current, V_{IN} High[e]	I_{IH}	V_{IN} Under Test = 2.4 V	Full	−1	0.05	1	
Dynamic Characteristics							
Turn-On Time	t_{ON}	$R_L = 300\ \Omega$, $C_L = 35$ pF $V_S = \pm 3.5$ V See Figure 2	Room Full		21	50 60	ns
Turn-Off Time	t_{OFF}		Room Full		16	35 40	
Break-Before-Make Time Delay[e]	t_D	DG413L Only, $V_S = 3.5$ V $R_L = 300\ \Omega$, $C_L = 35$ pF	Room		6		
Charge Injection[e]	Q	$V_g = 0$ V, $R_g = 0\ \Omega$, $C_L = 10$ nF	Room		5		pC
Off Isolation[e]	OIRR	$R_L = 50\ \Omega$, $C_L = 5$ pF, f = 1 MHz	Room		68		dB
Channel-to-Channel Crosstalk[e]	X_{TALK}		Room		85		
Source Off Capacitance[e]	$C_{S(off)}$	f = 1 MHz	Room		9		pF
Drain Off Capacitance[e]	$C_{D(off)}$		Room		9		
Channel On Capacitance[e]	$C_{D(on)}$		Room		20		
Power Supplies							
Positive Supply Current[e]	I+	V_{IN} = 0 or 5 V	Room Full		0.03	1 5	μA
Negative Supply Current[e]	I−		Room Full	−1 −5	−0.002		
Logic Supply Current[e]	I_L		Room Full		0.002	1 5	
Ground Current[e]	I_{GND}		Room Full	−1 −5	−0.002		

SPECIFICATIONS[a] (SINGLE SUPPLY 5 V)

Parameter	Symbol	Test Conditions Unless Specified $V+ = 5\ V$, $V- = 0\ V$ $V_L = 5\ V$, $V_{IN} = 2.4\ V$, $0.8\ V^f$	Temp[b]	Limits −40 to 85°C Min[d]	Typ[c]	Max[d]	Unit
Analog Switch							
Analog Signal Range[e]	V_{ANALOG}		Full			5	V
Drain-Source On-Resistance[e]	$r_{DS(on)}$	$V+ = 4.5$ V, $I_S = -5$ mA $V_D = 1$ V, 3.5 V	Room Full		35	50 75	Ω
Dynamic Characteristics							
Turn-On Time[e]	t_{ON}	$R_L = 300\ \Omega$, $C_L = 35$ pF $V_S = 3.5$ V, See Figure 2	Room Hot		27	50 60	ns
Turn-Off Time[e]	t_{OFF}		Room Hot		15	30 40	
Break-Before-Make Time Delay[e]	t_D	DG413L Only, $V_S = 3.5$ V, $R_L = 300\ \Omega$, $C_L = 35$ pF	Room		6		
Charge Injection[e]	Q	$V_g = 0$ V, $R_g = 0\ \Omega$, $C_L = 10$ nF	Room		0.5		pC

SPECIFICATIONS[a] (SINGLE SUPPLY 5 V)

Parameter	Symbol	Test Conditions Unless Specified V+ = 5 V, V− = 0 V V_L = 5 V, V_{IN} = 2.4 V, 0.8 V[f]	Temp[b]	Limits −40 to 85°C Min[d]	Typ[c]	Max[d]	Unit
Power Supplies							
Positive Supply Current[e]	I+		Room Hot		0.02	1 5	
Negative Supply Current[e]	I−	V_{IN} = 0 or 5 V	Room Hot	−1 −5	−0.002		µA
Logic Supply Current[e]	I_L		Room Hot		0.002	1 5	
Ground Current[e]	I_{GND}		Room Hot	−1 −5	−0.002		

SPECIFICATIONS[a] (SINGLE SUPPLY 3 V)

| Parameter	Symbol	Test Conditions Unless Specified V+ = 3 V, V− = 0 V V_L = 3 V, V_{IN} = 0.4 V[f]	Temp[b]	Limits −40 to 85°C Min[d]	Typ[c]	Max[d]	Unit
Analog Switch							
Analog Signal Range[e]	V_{ANALOG}		Full	0		3	V
Drain-Source On-Resistance	$r_{DS(on)}$	V+ = 2.7 V, V− = 0 V I_S = −10 mA, V_D = 0.5, 2.2 V	Room Full		65	80 100	Ω
Switch Off Leakage Current[g]	$I_{S(off)}$	V+ = 3 V, V− = 0 V V_D = 1, 2 V, V_S = 2, 1 V	Room Full	−0.1 −2.5	±0.01	0.1 2.5	nA
	$I_{D(off)}$		Room Full	−0.1 −2.5	±0.01	0.1 2.5	
Channel On Leakage Current[g]	$I_{D(on)}$	V+ = 3 V, V− = 0 V V_S = V_D = 1, 2 V	Room Full	−0.2 −5	±0.01	0.2 5	
Digital Control							
Input Current, V_{IN} Low	I_{IL}	V_{IN} Under Test = 0.4 V	Full	−1	0.005	1	µA
Input Current, V_{IN} High	I_{IH}	V_{IN} Under Test = 2.4 V	Full	−1	0.005	1	
Dynamic Characteristics							
Turn-On Time	t_{ON}	R_L = 300 Ω, C_L = 35 pF V_S = 1.5 V See Figure 2	Room Full		50	85 110	ns
Turn-Off Time	t_{OFF}		Room Full		30	60 85	
Break-Before-Make Time Delay	t_D	DG413L Only, V_S = 1.5 V R_L = 300 Ω, C_L = 35 pF	Room		6		
Charge Injection[e]	Q	V_g = 0 V, R_g = 0 Ω, C_L = 10 nF	Room		1		pC
Off Isolation[e]	OIRR	R_L = 50 Ω, C_L = 5 pF, f = 1 MHz	Room		68		dB
Channel-to-Channel Crosstalk[e]	X_{TALK}		Room		85		
Source Off Capacitance[e]	$C_{S(off)}$		Room		6		pF
Drain Off Capacitance[e]	$C_{D(off)}$	f = 1 MHz	Room		6		
Channel On Capacitance[e]	$C_{D(on)}$		Room		20		

Notes:
a. Refer to PROCESS OPTION FLOWCHART.
b. Room = 25°C, Full = as determined by the operating temperature suffix.
c. Typical values are for DESIGN AID ONLY, not guaranteed nor subject to production testing.
d. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this data sheet.
e. Guaranteed by design, not subject to production test.
f. V_{IN} = input voltage to perform proper function.
g. Leakage parameters are guaranteed by worst case test conditions and not subject to test.
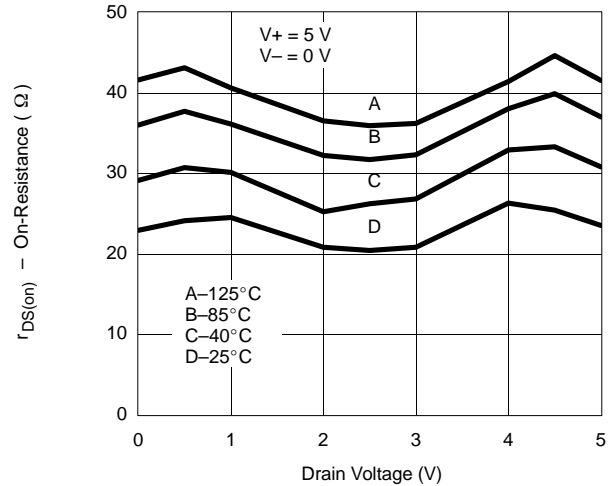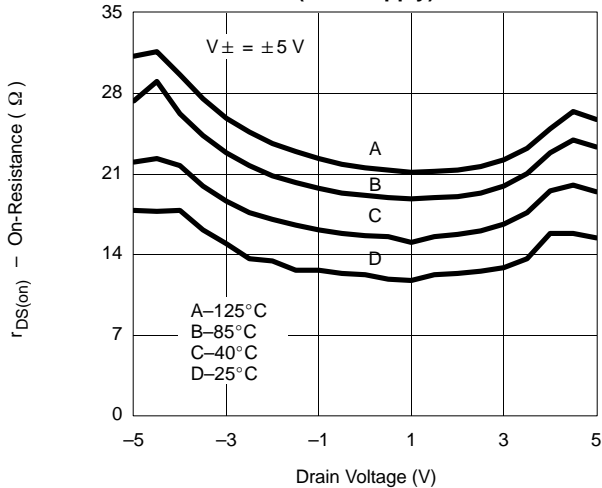
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

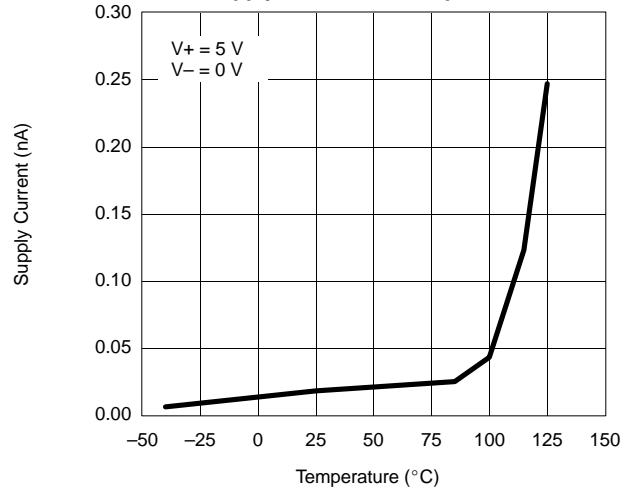**r$_{DS(on)}$ vs. Drain Voltage
(Single Supply)**
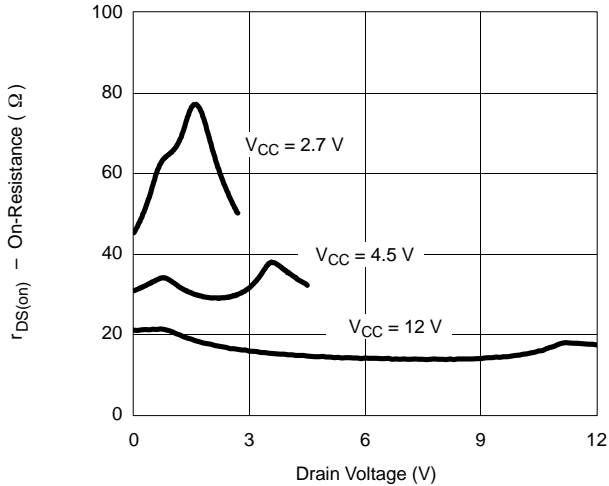
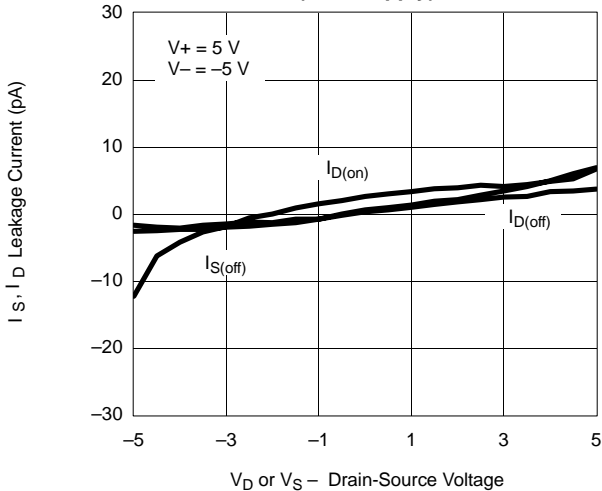**r$_{DS(on)}$ vs. Drain Voltage and Temperature
(Single Supply)**

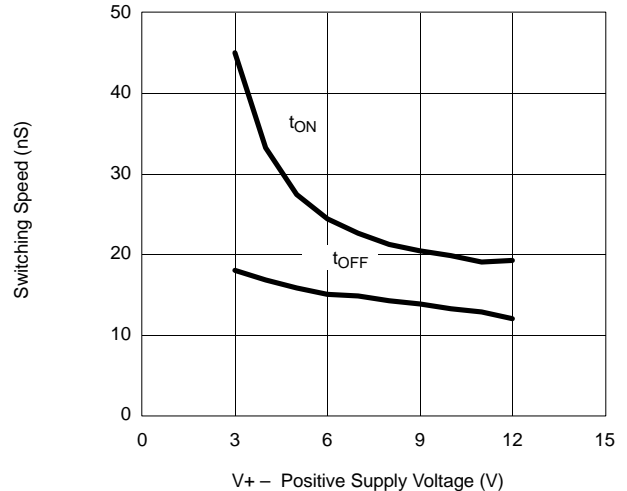**r$_{DS(on)}$ vs. Drain Voltage and Temperature
(Dual Supply)**

Supply Current vs. Temperature
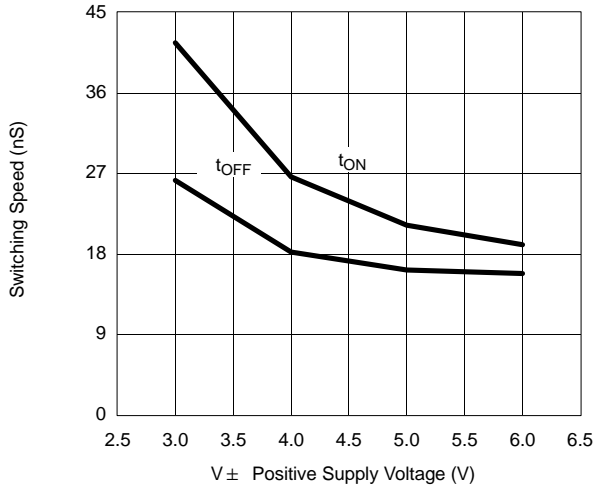
**Leakage Current vs. Analog Voltage
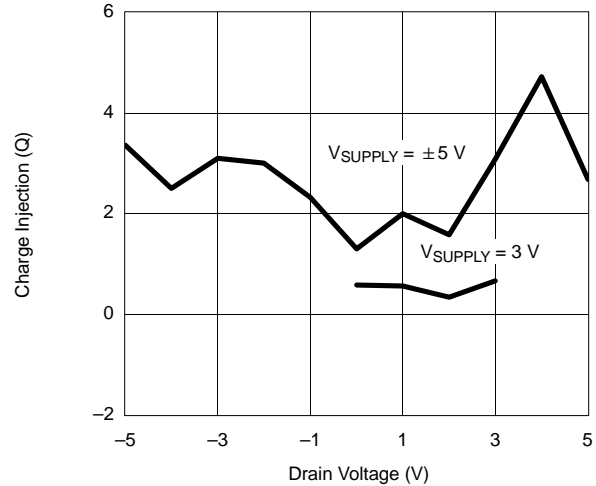(Dual Supply)**

Switching Time vs. Single Supply
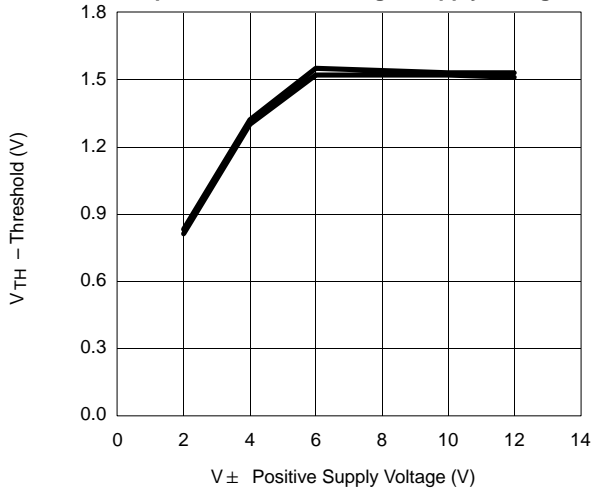
TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

Switching Time vs. Dual Supply

Charge Injection vs. Drain Voltage

Input Threshold vs. Single Supply Voltage

Drain Capacitance vs. Drain Voltage (Single Supply)
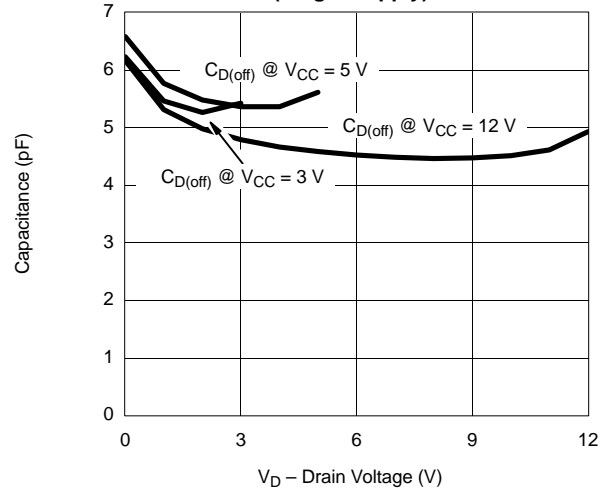
Capacitance vs. Analog Signal (Dual Supply)
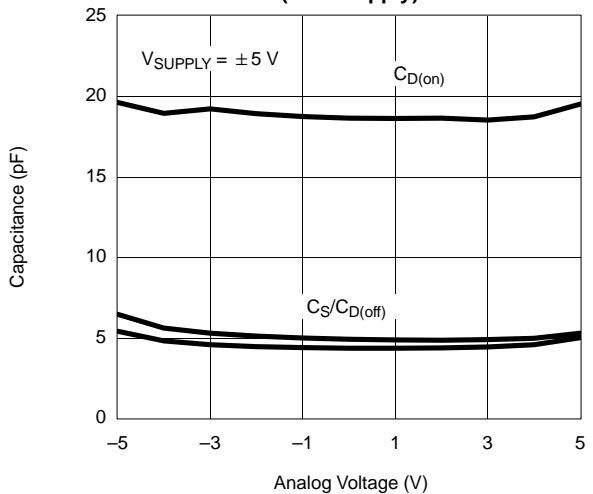
Insertion Loss, Off Isolation and Crosstalk vs. Frequency (Single Supply)
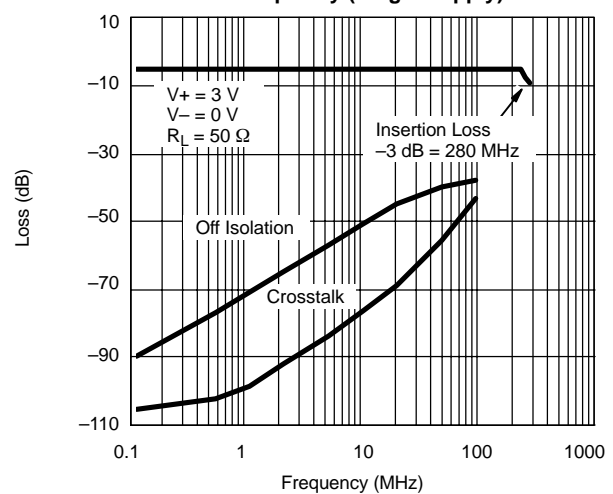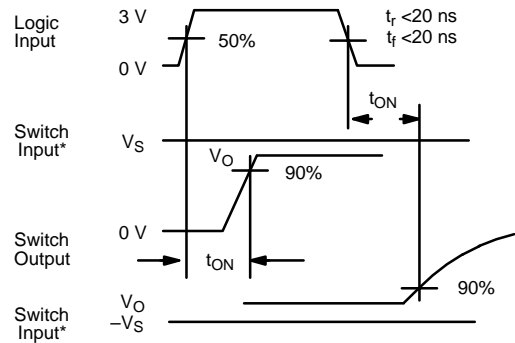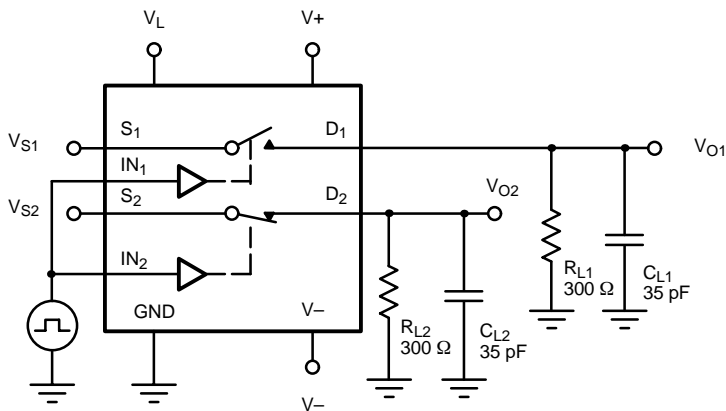
SCHEMATIC DIAGRAM (TYPICAL CHANNEL)
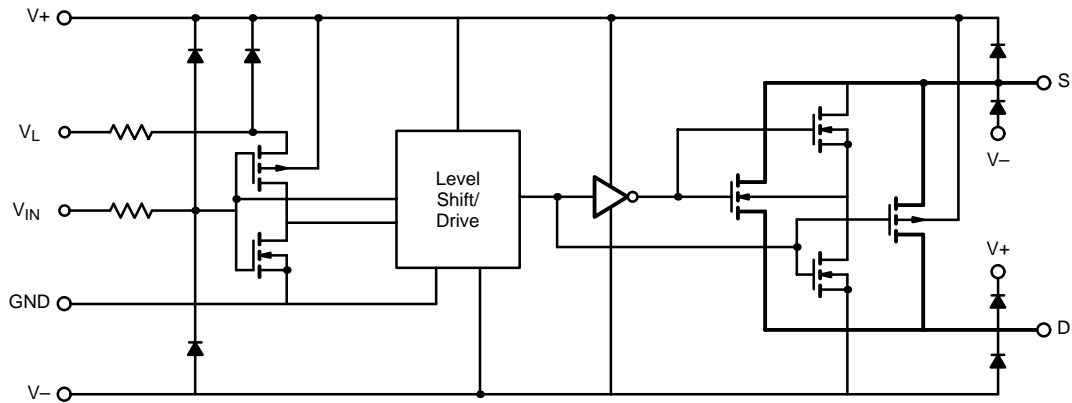
FIGURE 1.

TEST CIRCUITS
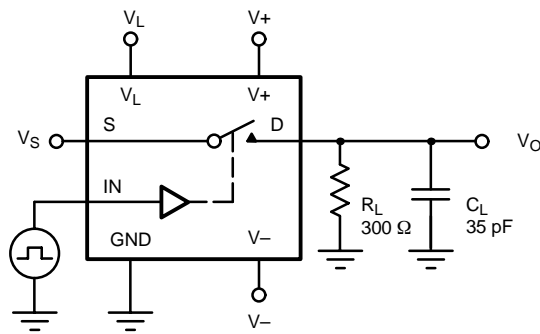
C_L (includes fixture and stray capacitance)

$$V_O = V_S \frac{R_L}{R_L + r_{DS(on)}}$$

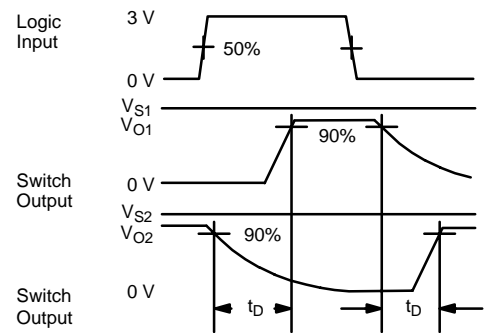**FIGURE 2.** Switching Time

Note: Logic input waveform is inverted for switches that have the opposite logic sense control

C_L (includes fixture and stray capacitance)

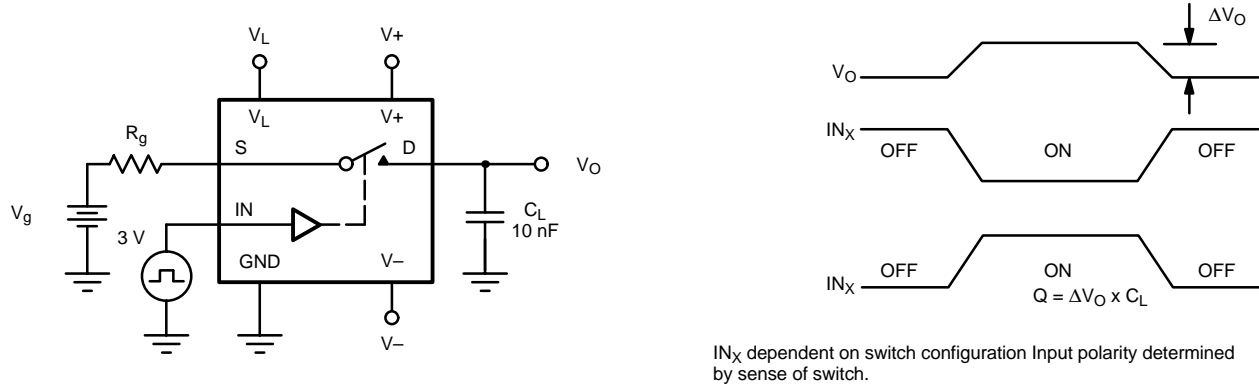**FIGURE 3.** Break-Before-Make (DG413L)
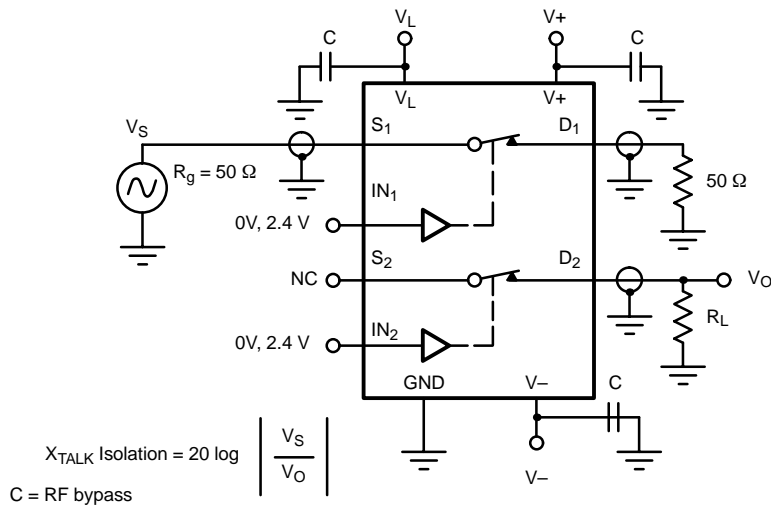
TEST CIRCUITS

FIGURE 4. Charge Injection

$$X_{TALK} \text{ Isolation} = 20 \log \left| \frac{V_S}{V_O} \right|$$

C = RF bypass

FIGURE 5. Crosstalk

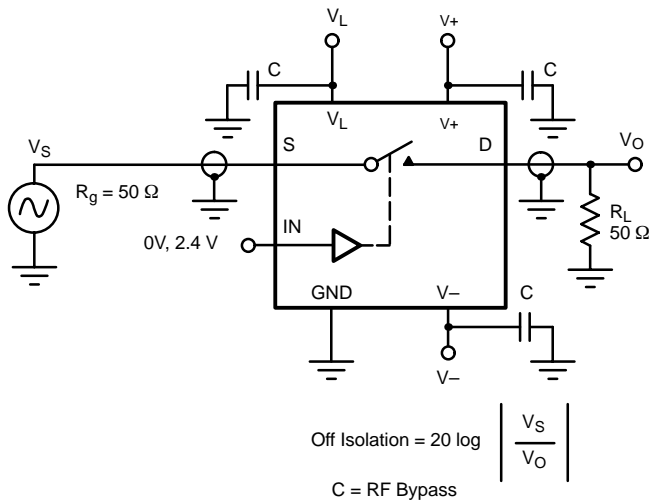$$\text{Off Isolation} = 20 \log \left| \frac{V_S}{V_O} \right|$$
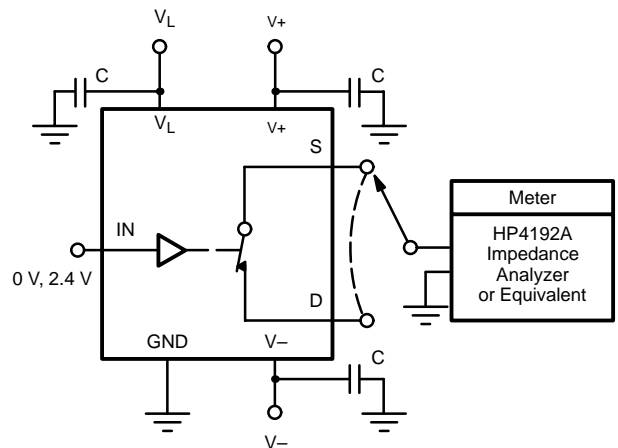
C = RF Bypass

FIGURE 6. Off Isolation

FIGURE 7. Source/Drain Capacitances